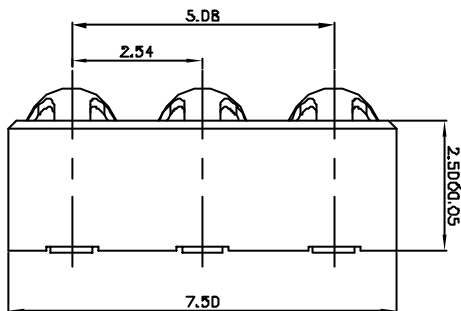
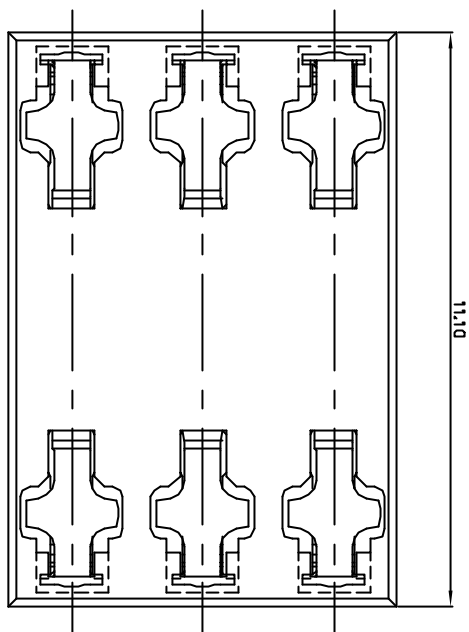
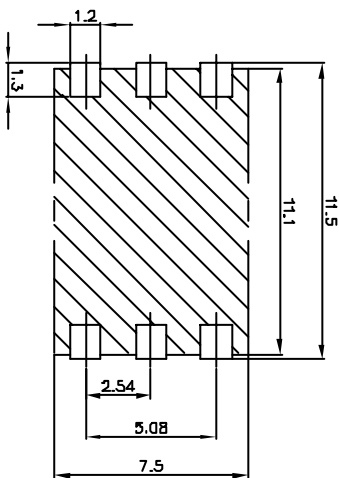
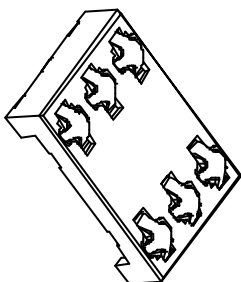


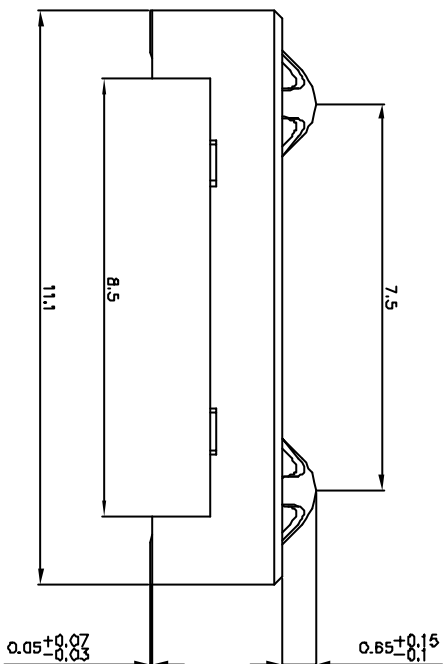
PROD NO
11141573-1114F



NOTES:
1. MATERIAL & FINISH
INSULATOR: HIGH TEMPERATURE PLASTIC, UL94V-0
COLOR: BLACK
CONTACT: COPPER ALLOY.
PLATING: THE CONTACTING AREA IS PLATED WITH 30u" GOLD,
OTHER AREA GOLD FLASH, OVERALL 50u" NICKEL
UNDERPLATED.



RECOMMENDED PCB LAYOUT; SCALE: 5/1



NOTE: R&HS COMPATIBLE PRODUCT SPECIFICATIONS
a. PLATING: "LF" MEANS THE PRODUCT IS LEAD FREE. GOLD FLASH PLATING OVER 1.27um MIN.
NICKEL UNDERPLATE ON SOLDER AREA.
b. MANUFACTURING PROCESS COMPATIBILITY: THE HOUSING WILL WITHSTAND EXPOSURE TO 260C±5C°
SOLDER BATH TEMPERATURE FOR 11 SECONDS IN IR-REFLOW APPLICATION.

mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY		A FCI www.fcimed.com		
itr	ecn no	dr	date	X ±.35 XX ±.20 .XX ±.05		projection	title	product family	SIM CARD	code
A	104-0352	JH	9/1/04	linear			SIM CARD 2.5H	SIM CARD	10040573	—
B	105-0280	JH	12/12/04							sheet
				angles 0° ±2°						1 of 1
				dr	450N RSU	9/1/04	N/A	A4	10040573	—
				engr	450N RSU	9/1/04				
				cltr	STERLING LNI	9/15/04				
				qpld	HC UDU	9/15/04				
sheet	revision	B								
index	sheet	1								

ACAD

3

copy code
22526

4